

BFF1303: ELECTRICAL / ELECTRONICS ENGINEERING

Analog Electronics

Ismail Mohd Khairuddin , Zulkifil Md Yusof
Faculty of Manufacturing Engineering
Universiti Malaysia Pahang

Semiconductor Diodes & Circuits

BFF1303 ELECTRICAL/ELECTRONICS ENGINEERING



Faculty of Manufacturing

Universiti Malaysia Pahang
Kampus Pekan, Pahang Darul Makmur
Tel: +609-424 5800
Fax: +609-4245888

Contents:

- Outcomes
- Semiconductor Diodes
- Diode Characteristics
- Semiconductor Material
- P-N Junction
- Diode Operating Conditions
- Actual Diode Characteristics
- Zener Region
- Forward Bias Region
- Temperature Effects
- Resistance Levels
- Diode Equivalent Circuit
- Reverse Recovery Time
- Diode Specification Sheet
- Diode Symbol & Packaging
- Various Diode
- Load-Line Analysis
- Series-Parallel Configuration

Outcomes

Understand the diode characteristics and its model

Learn the types of diodes

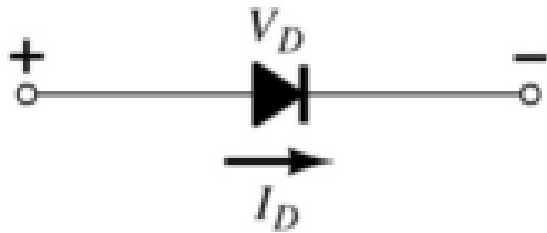
Learn the series and parallel operation of diodes

Analyze and design simple voltage-regulator circuits.

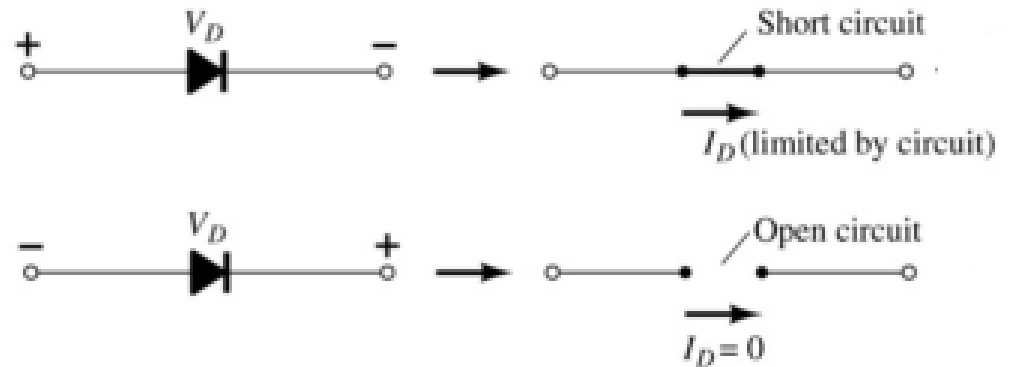
Understand various rectifiers and wave-shaping circuits

Semiconductor Diodes

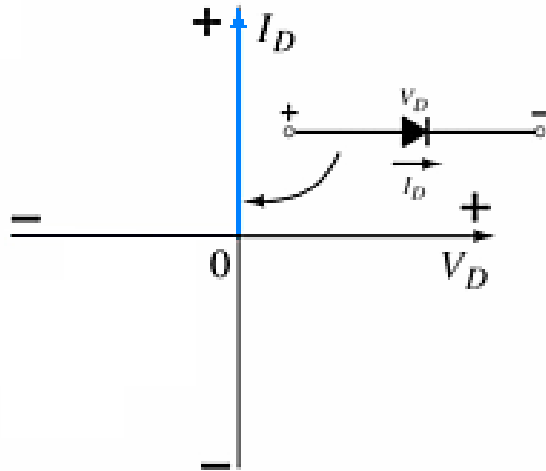
The diode is a 2-terminal device.



A diode ideally conducts in only one direction.

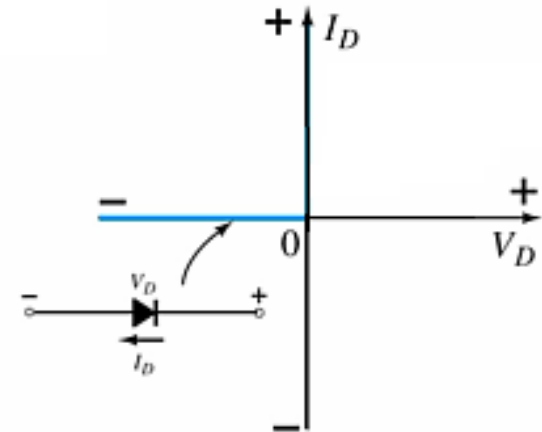


Conduction Region



- ❑ The voltage across the diode is 0 V
- ❑ The current is infinite
- ❑ The forward resistance is defined as $R_F = V_F / I_F$
- ❑ The diode acts like a short

Non-Conduction Region



- ❑ All of the voltage is across the diode
- ❑ The current is 0 A
- ❑ The reverse resistance is defined as $R_R = V_R / I_R$
- ❑ The diode acts like open



- Materials commonly used in the development of semiconductor devices:
 - Silicon (Si)
 - Germanium (Ge)
 - Gallium Arsenide (GaAs)

Doping

- The electrical characteristics of silicon and germanium are improved by adding materials in a process called doping.
- There are just two types of doped semiconductor materials:



n-type

- n-type materials contain an excess of conduction band electrons.

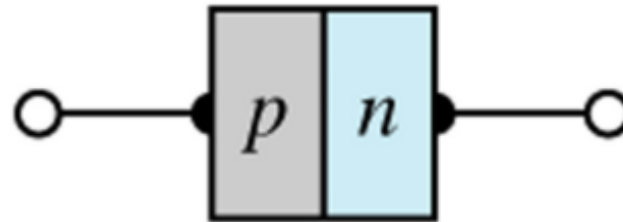
p-type

- p-type materials contain an excess of valence band holes.



P-N Junction

- One end of a silicon or germanium crystal can be doped as a p-type material and the other end as an n-type material.

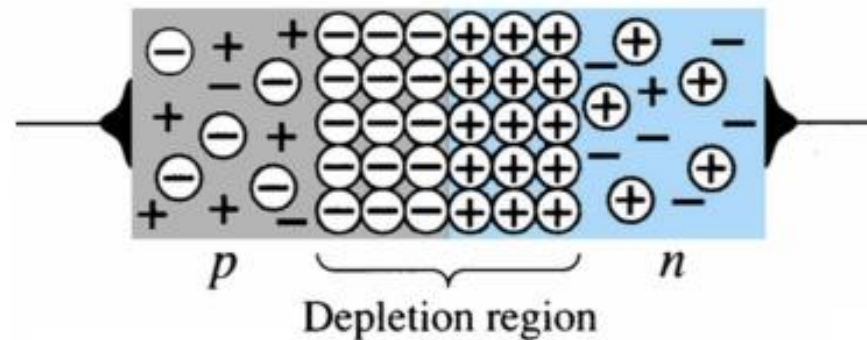


- At the p-n junction, the excess conduction-band electrons on the n-type side are attracted to the valence-band holes on the p-type side.
- The electrons in the n-type material migrate across the junction to the p-type material (electron flow).



P-N Junction

- ❑ The electron migration results in a negative charge on the p-type side of the junction and a positive charge on the n-type side of the junction.
- ❑ The electron migration results in a negative charge on the p-type side of the junction and a positive charge on the n-type side of the junction.



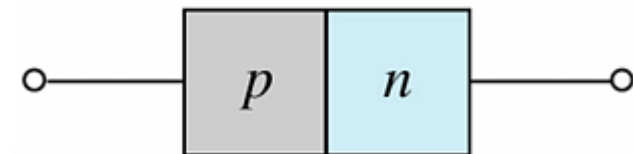
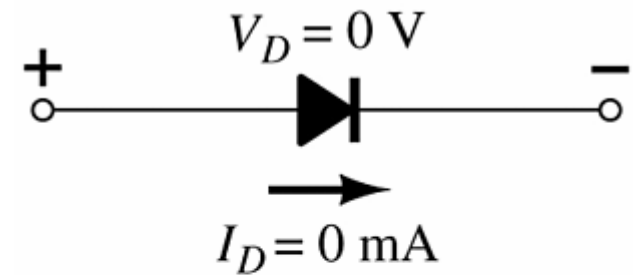
- ❑ The result is the formation of a depletion region around the junction.



- ❏ A diode has three operating conditions:
 - ❏ No bias
 - ❏ Forward bias
 - ❏ Reverse bias

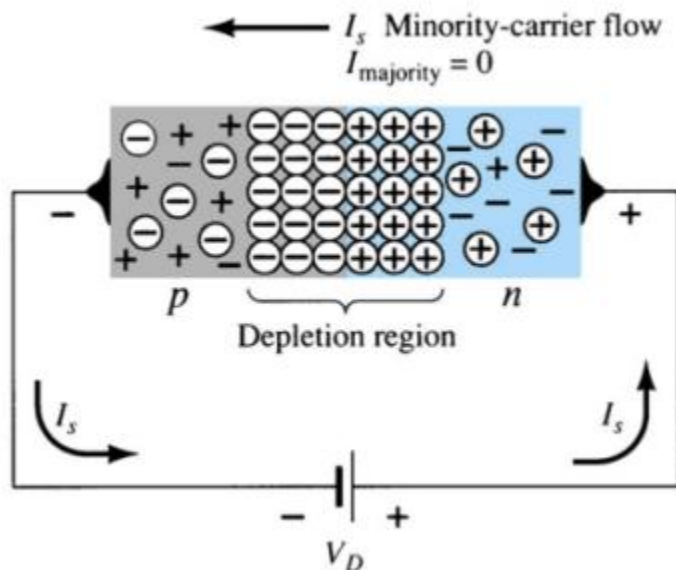
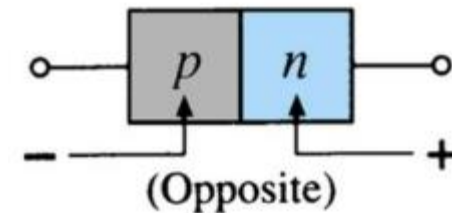
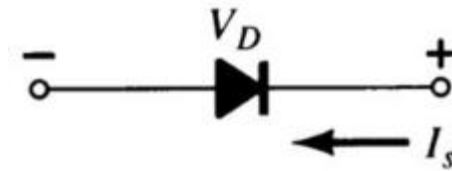
No Bias

- ❏ No external voltage is applied: $V_D = 0 \text{ V}$
- ❏ No current is flowing: $I_D = 0 \text{ A}$
- ❏ Only a modest depletion region exists



Reverse Bias

- External voltage is applied across the p-n junction in the opposite polarity of the p- and n-type materials.



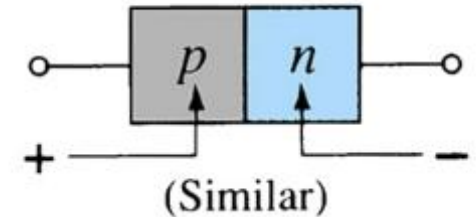
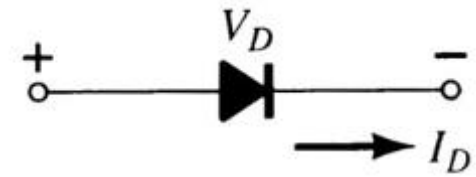
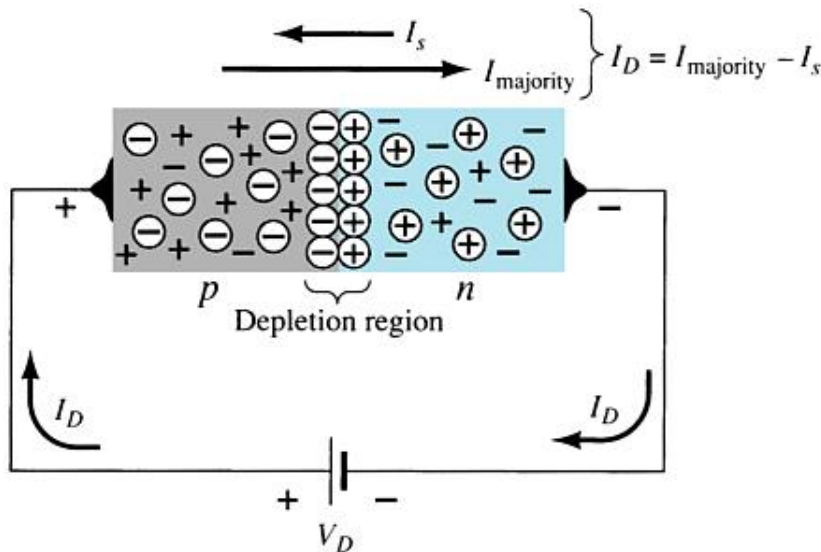
- The reverse voltage causes the depletion region to widen.
- The electrons in the n-type material are attracted toward the positive terminal of the voltage source.
- The holes in the p-type material are attracted toward the negative terminal of the voltage source.



Diode Operating Conditions

Forward Bias

- External voltage is applied across the p-n junction in the same polarity as the p- and n-type materials.



- The forward voltage causes the depletion region to narrow.
- The electrons and holes are pushed toward the p-n junction.
- The electrons and holes have sufficient energy to cross the p-n junction.



Majority Carriers

- ❑ The majority carriers in n-type materials are electrons.
- ❑ The majority carriers in p-type materials are holes.

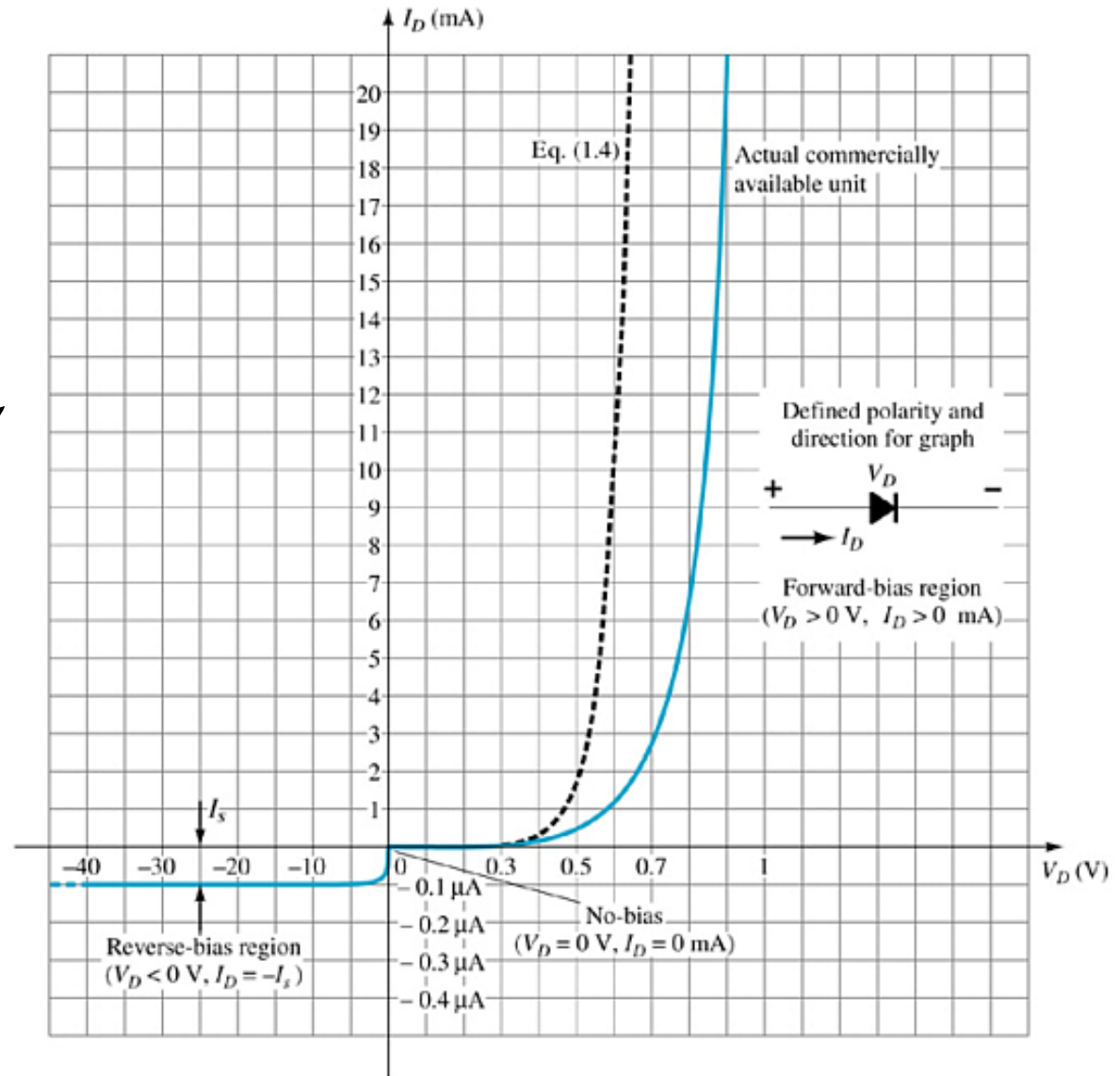
Minority Carriers

- ❑ The minority carriers in n-type materials are holes.
- ❑ The minority carriers in p-type materials are electrons.



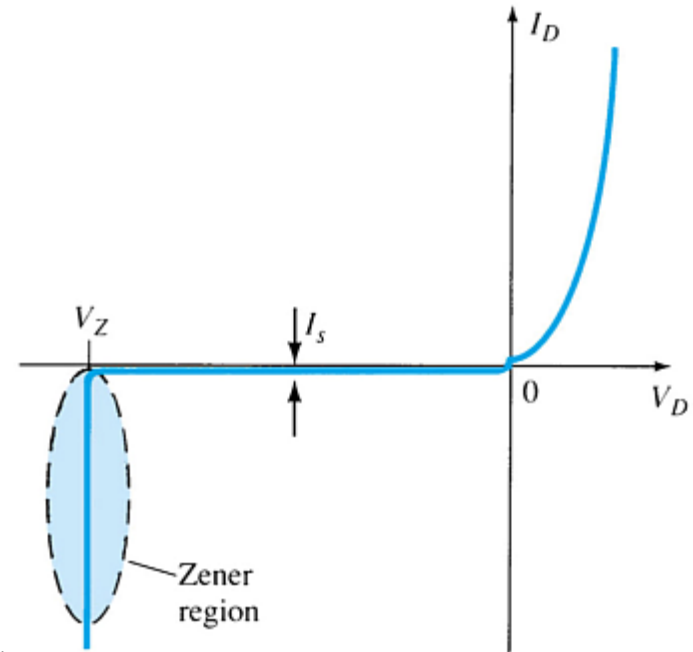
Actual Diode Characteristics

- Note the regions for no bias, reverse bias, and forward bias conditions.
- Carefully note the scale for each of these conditions.



Zener Region

- ❑ The Zener region is in the diode's reverse-bias region.
- ❑ At some point the reverse bias voltage is so large the diode breaks down and the reverse current increases dramatically.
- ❑ The maximum reverse voltage that won't take a diode into the zener region is called the **peak inverse voltage** or **peak reverse voltage**.
- ❑ The voltage that causes a diode to enter the zener region of operation is called the **zener voltage** (V_Z).



Forward Bias Region

- The point at which the diode changes from no-bias condition to forward-bias condition occurs when the electrons and holes are given sufficient energy to cross the $p-n$ junction. This energy comes from the external voltage applied across the diode.
- The forward bias voltage required for a:
 - gallium arsenide diode $\cong 1.2$ V
 - silicon diode $\cong 0.7$ V
 - germanium diode $\cong 0.3$ V



- ❑ As temperature increases it adds energy to the diode.
 - ❑ It reduces the required forward bias voltage for forward-bias conduction.
 - ❑ It increases the amount of reverse current in the reverse-bias condition.
 - ❑ It increases maximum reverse bias avalanche voltage.
- ❑ Germanium diodes are more sensitive to temperature variations than silicon or gallium arsenide diodes.



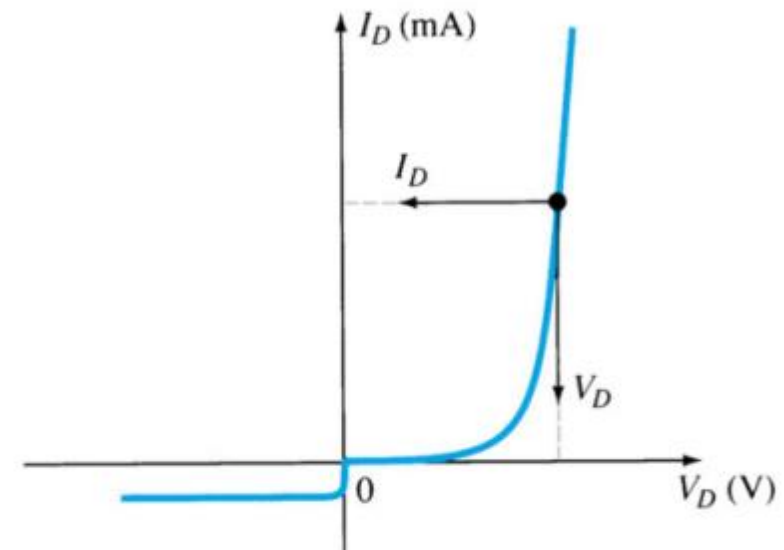
Resistance Levels

- ❑ Semiconductors react differently to DC and AC currents.
- ❑ There are three types of resistance:
 - ❑ DC (static) resistance.
 - ❑ AC (dynamic) resistance.
 - ❑ Average AC resistance.

For a specific applied DC voltage V_D , the diode has a specific current I_D , and a specific resistance R_D .

$$R_D = \frac{V_D}{I_D}$$

DC (static) resistance



AC (Dynamic) resistance

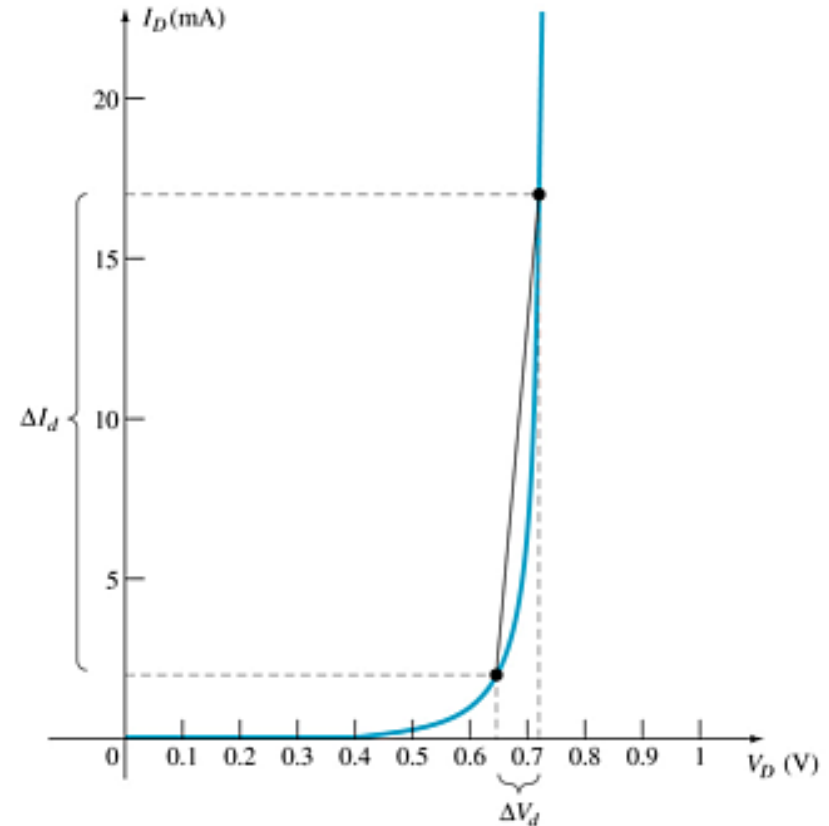
- In the forward bias region: $r'_d = \frac{26 \text{ mV}}{I_D} + r_B$
 - The resistance depends on the amount of current (I_D) in the diode.
 - The voltage across the diode is fairly constant (26 mV for 25°C).
 - r_B ranges from a typical 0.1 Ω for high power devices to 2 Ω for low power, general purpose diodes. In some cases r_B can be ignored.
- In the reverse bias region: $r'_d = \infty$
- The resistance is effectively infinite. The diode acts like an open.



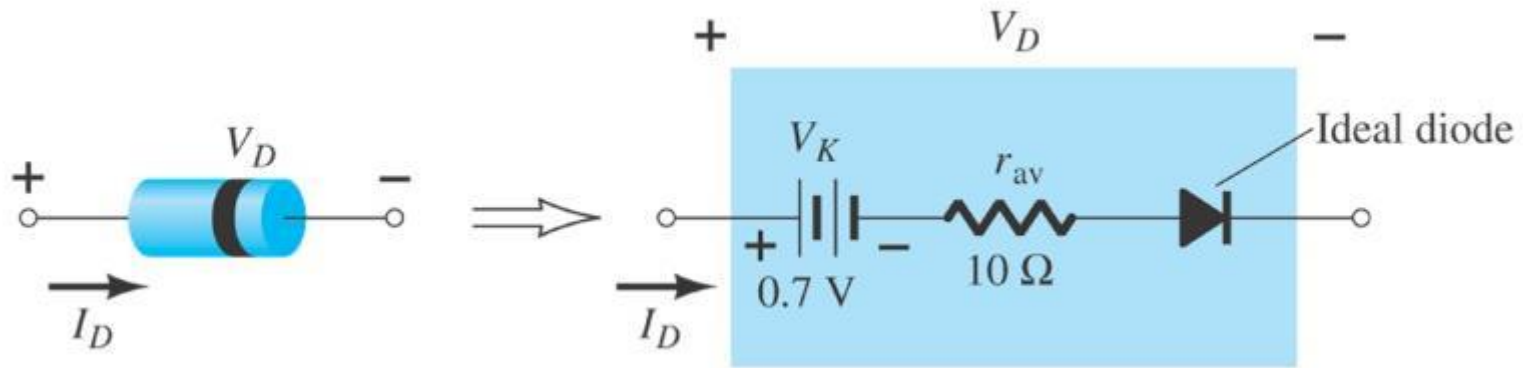
Average AC resistance

$$r_{av} = \frac{\Delta V_d}{\Delta I_d} \quad | \quad \text{pt. to pt.}$$

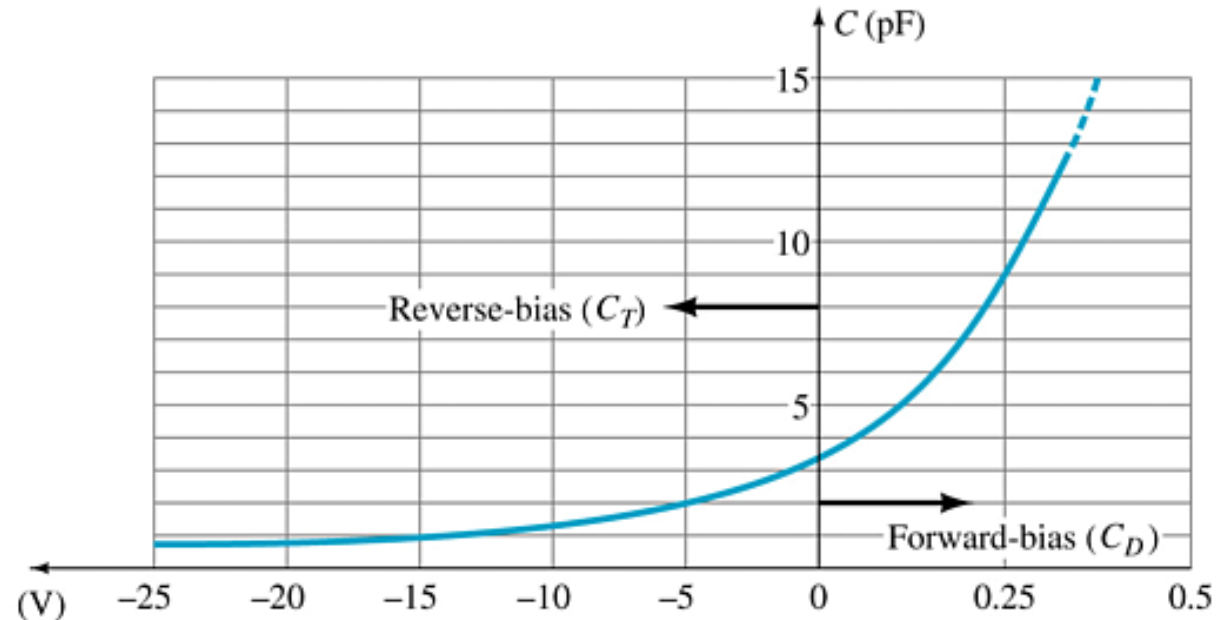
AC resistance can be calculated using the current and voltage values for two points on the diode characteristic curve.



Diode Equivalent Circuit



Diode Capacitance

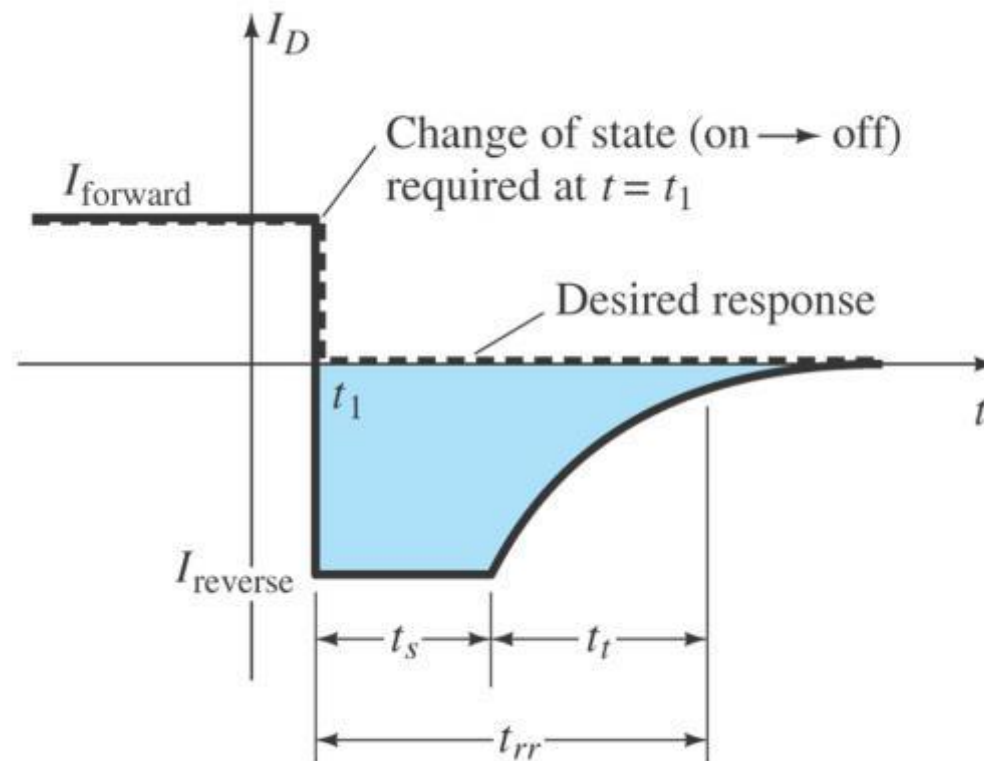


- ❑ In reverse bias, the depletion layer is very large. The diode's strong positive and negative polarities create capacitance, C_T . The amount of capacitance depends on the reverse voltage applied.
- ❑ In forward bias storage capacitance or diffusion capacitance (C_D) exists as the diode voltage increases.



Reverse Recovery Time (t_{rr})

- Reverse recovery time is the time required for a diode to stop conducting once it is switched from forward bias to reverse bias.

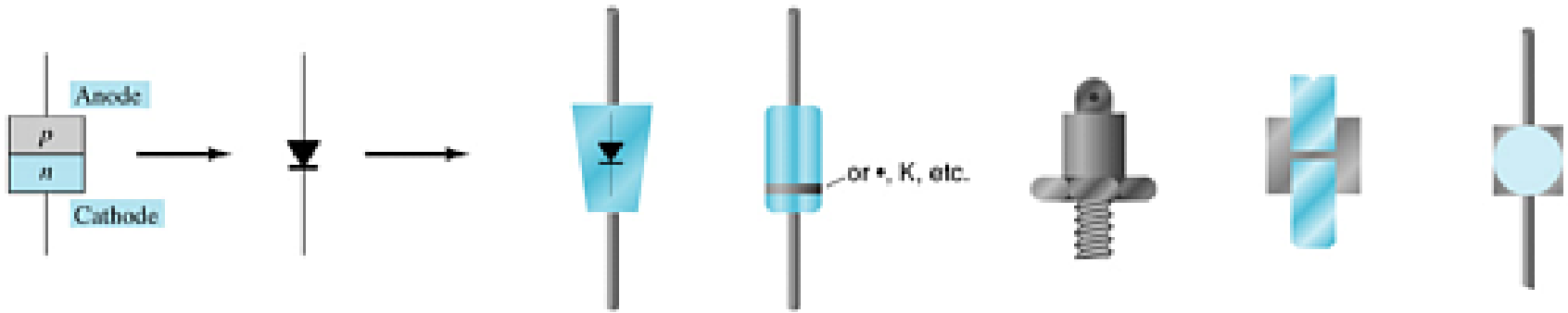


□ Data about a diode is presented uniformly for many different diodes. This makes cross-matching of diodes for replacement or design easier.

1. Forward Voltage (V_F) at a specified current and temperature
2. Maximum forward current (I_F) at a specified temperature
3. Reverse saturation current (I_R) at a specified voltage and temperature
4. Reverse voltage rating, PIV or PRV or $V(BR)$, at a specified temperature
5. Maximum power dissipation at a specified temperature
6. Capacitance levels
7. Reverse recovery time, t_{rr}
8. Operating temperature range



Diode Symbol & Packaging



The anode is abbreviated A
The cathode is abbreviated K

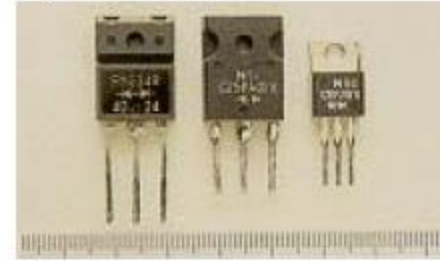


Various Diode

Normal Diode (Small Signal)



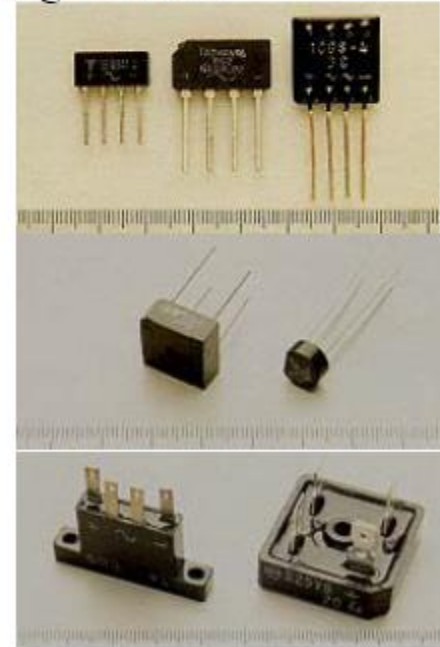
Array Diode



High Current Diode



Bridge Diode



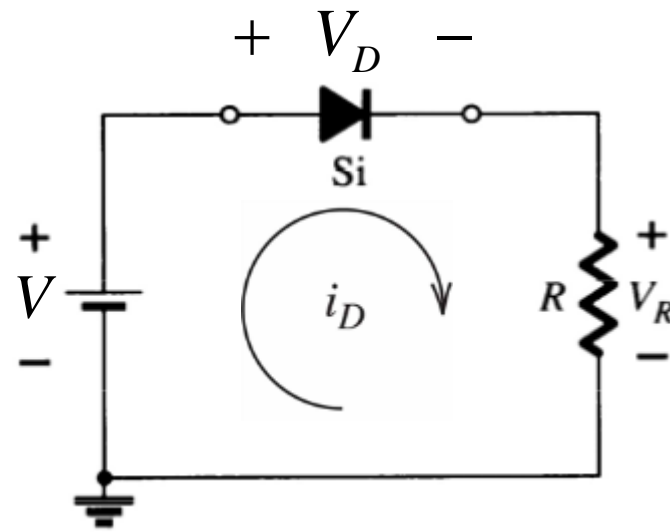
High Voltage Diode



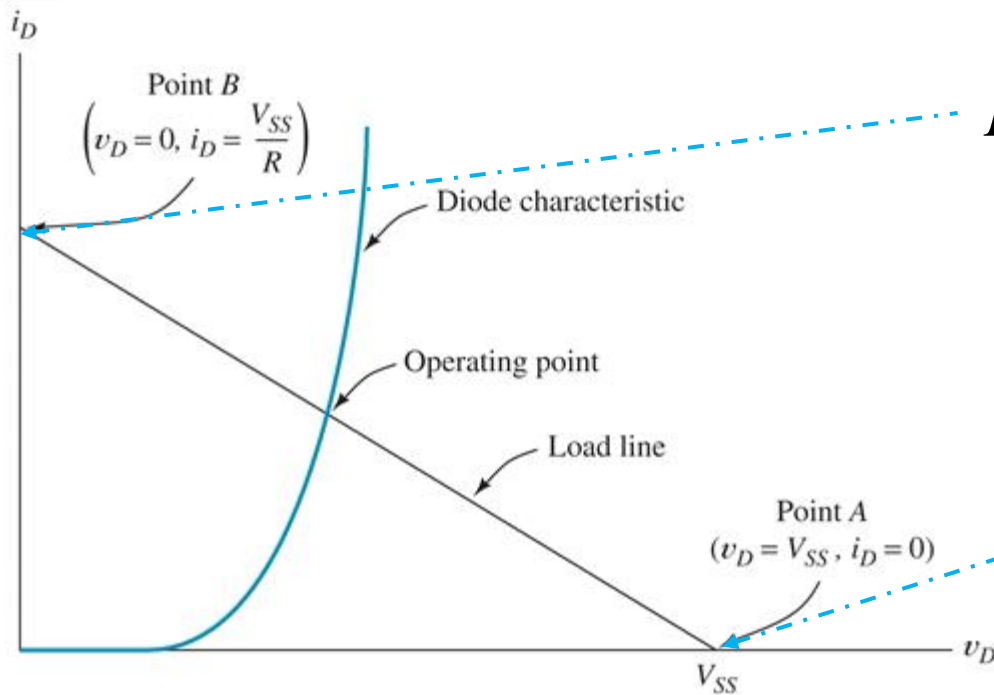
- The load line plots all possible combinations of diode current (I_D) and voltage (V_D) for a given circuit. The maximum I_D equals V/R , and the maximum V_D equals V .
- The point where the load line and the characteristic curve intersect is the Q-point, which identifies I_D and V_D for a particular diode in a given circuit.



Load-Line Analysis



$$-V + V_D + I_D R$$



$$I_D = \frac{V}{R} \Big|_{V_D=0}$$

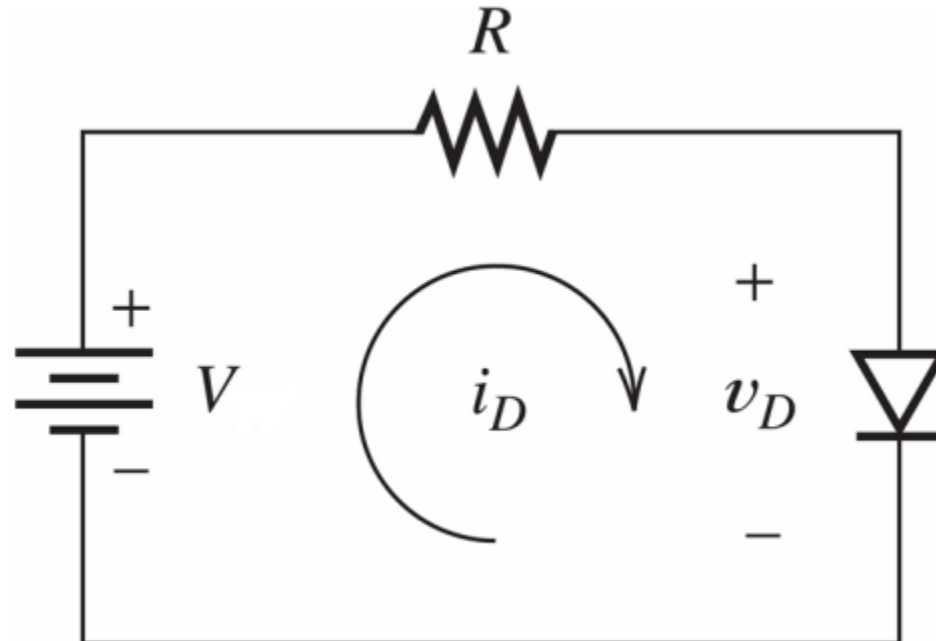
$$V_D = V \Big|_{I_D=0}$$



Example #1

Find the diode voltage and current operating point when

$$V = 2\text{ V}, R = 1\text{ k}\Omega$$



Example #1

Solution

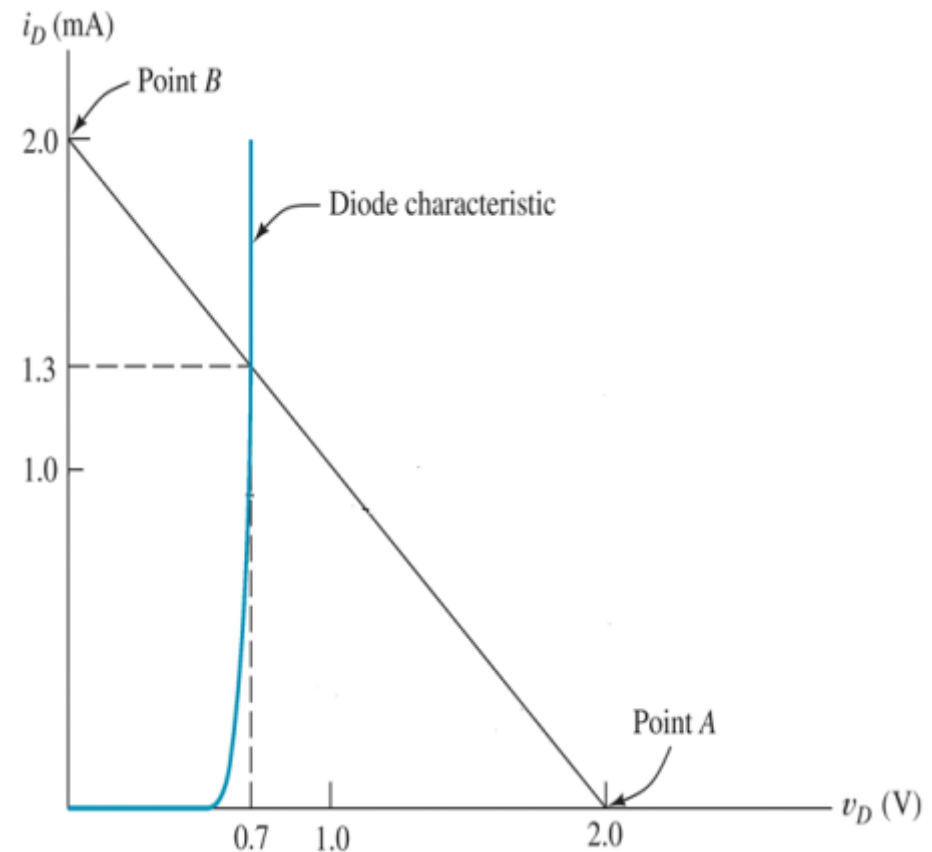
Substituting $V_D = 0$ and the value of V, R into $V = Ri_D + V_D$

then $i_D = 2 \text{ mA}$

Substituting $i_D = 0$ $V_D = 2 \text{ V}$

$I_{DQ} \cong 1.3 \text{ mA}$

$V_{DQ} \cong 0.7 \text{ V}$



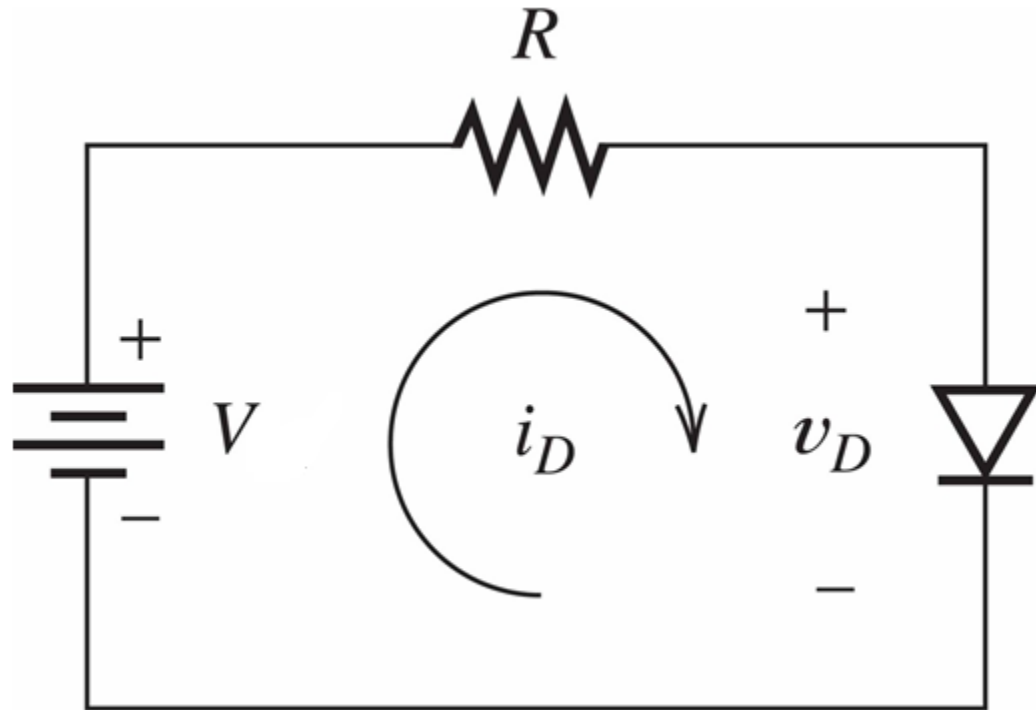
Example #2

Find the diode voltage and current operating point when

$$V = 2\text{ V}, R = 100\ \Omega$$

$$V = 15\text{ V}, R = 1\text{ k}\Omega$$

$$V = 1\text{ V}, R = 20\ \Omega$$

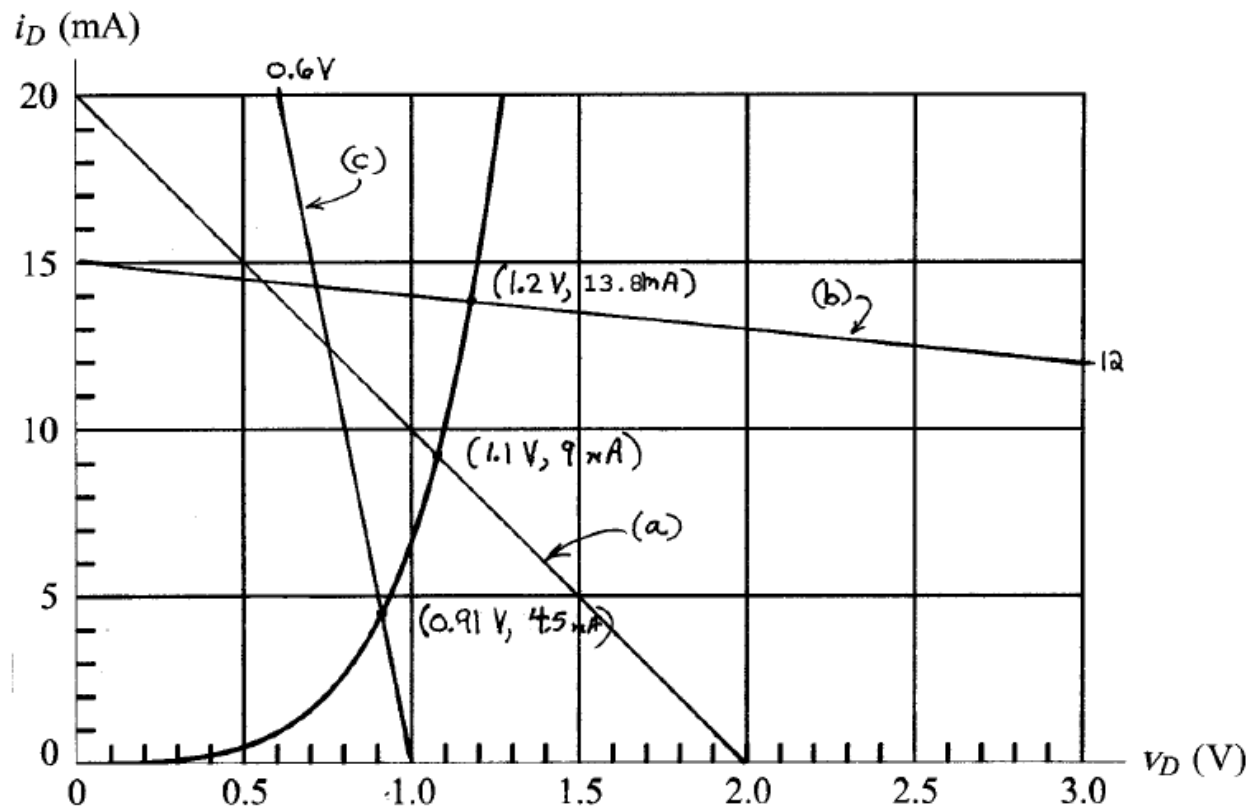


Example #2

$$V_{DQ} \cong 1.1 \text{ V}; I_{DQ} \cong 9 \text{ mA}$$

$$V_{DQ} \cong 1.2 \text{ V}; I_{DQ} \cong 13.8 \text{ mA}$$

$$V_{DQ} \cong 0.91 \text{ V}; I_{DQ} \cong 4.5 \text{ mA}$$



Series - Parallel Diode Configuration

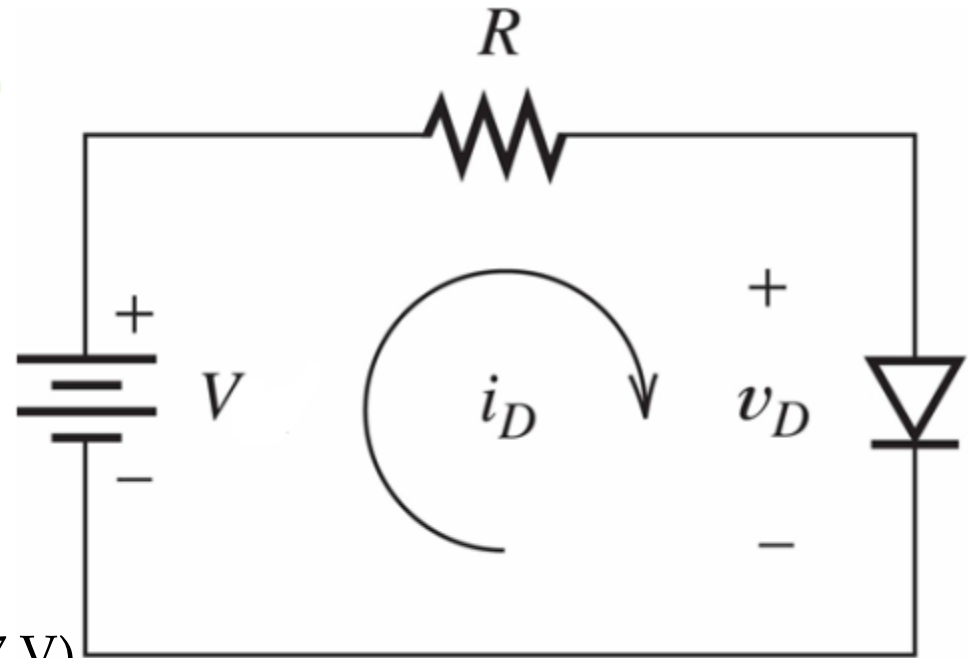
Forward Bias

Constants

- Silicon Diode: $V_D = 0.7 \text{ V}$
- Germanium Diode: $V_D = 0.3 \text{ V}$

Analysis (for silicon)

- $V_D = 0.7 \text{ V}$ (or $V_D = V$ if $V < 0.7 \text{ V}$)
- $V_R = V - V_D$
- $I_D = I_R = I_T = V_R / R$



Reverse Bias

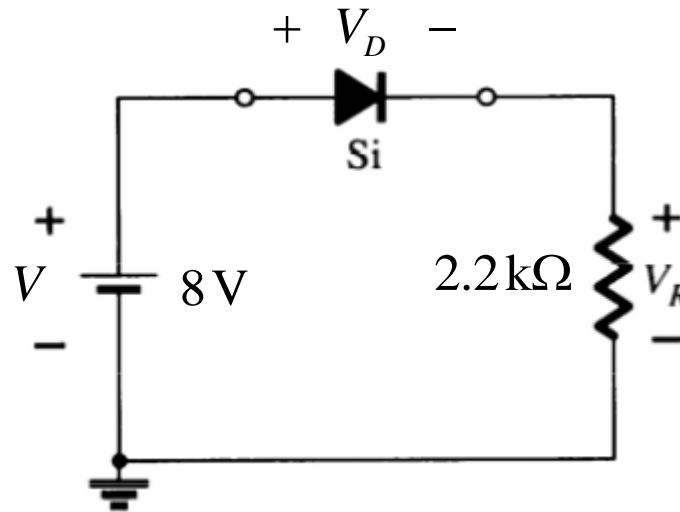
Diodes ideally behave as open circuits

Analysis (for silicon)

- $V_D = V$
- $V_R = 0 \text{ V}$
- $I_D = 0 \text{ A}$

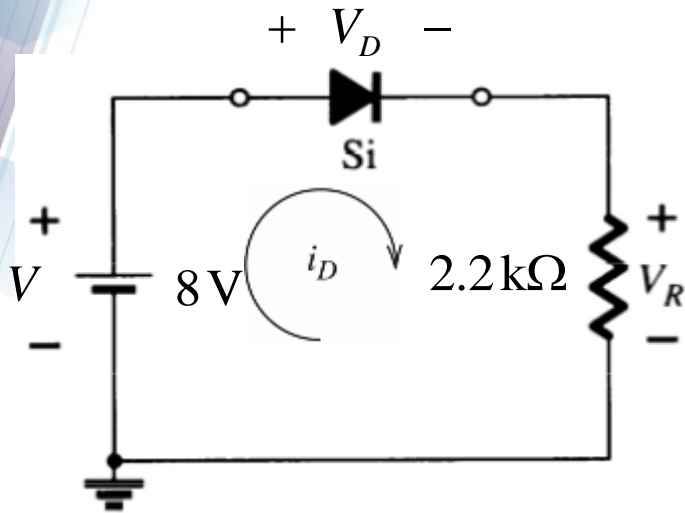
Example #2

For the series diode configuration, determine V_D , V_R , and I_D



Example #2

Solution



Since the input voltage V establish a current in the clockwise direction to match the arrow of the symbol, so the diode is operating in **forward bias** and is in the **on** state

$$\text{Then } V_D = 0.7 \text{ V}$$

$$V_R = V - V_D$$

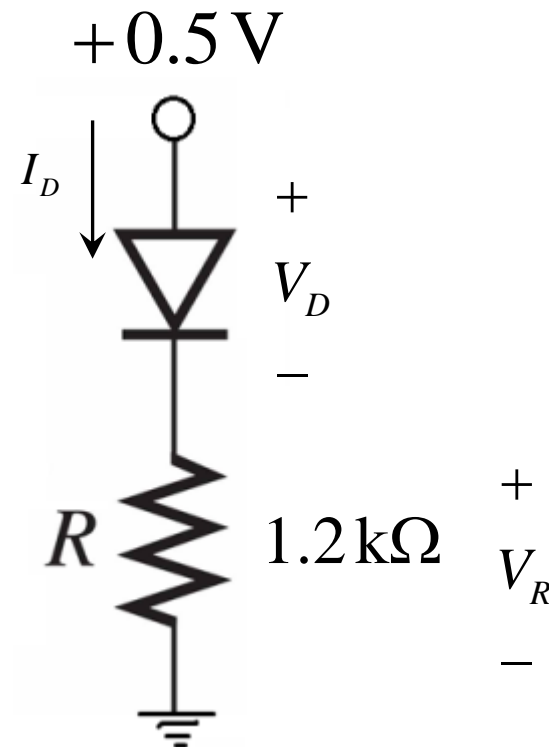
$$V_R = 8 - 0.7 = 7.3 \text{ V}$$

$$I_D = I_R = \frac{V_R}{R}$$

$$I_D = \frac{7.3}{2.2\text{k}} = 3.32 \text{ mA}$$

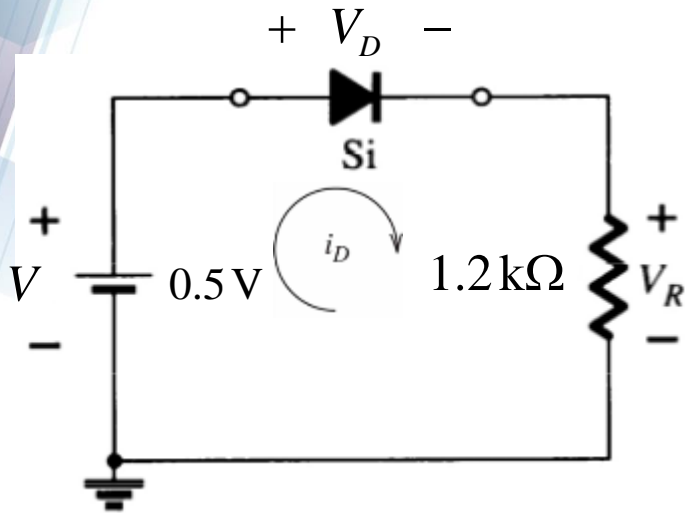
Example #3

For the series diode configuration, determine V_D , V_R , and I_D



Example #3

Solution



Since the input voltage V establish a current in the clockwise direction to match the arrow of the symbol, but the value of applied voltage is insufficient to turn the diode on.

$$\text{Then } V_D = V = 0.5 \text{ V}$$

$$I_D = 0 \text{ A}$$

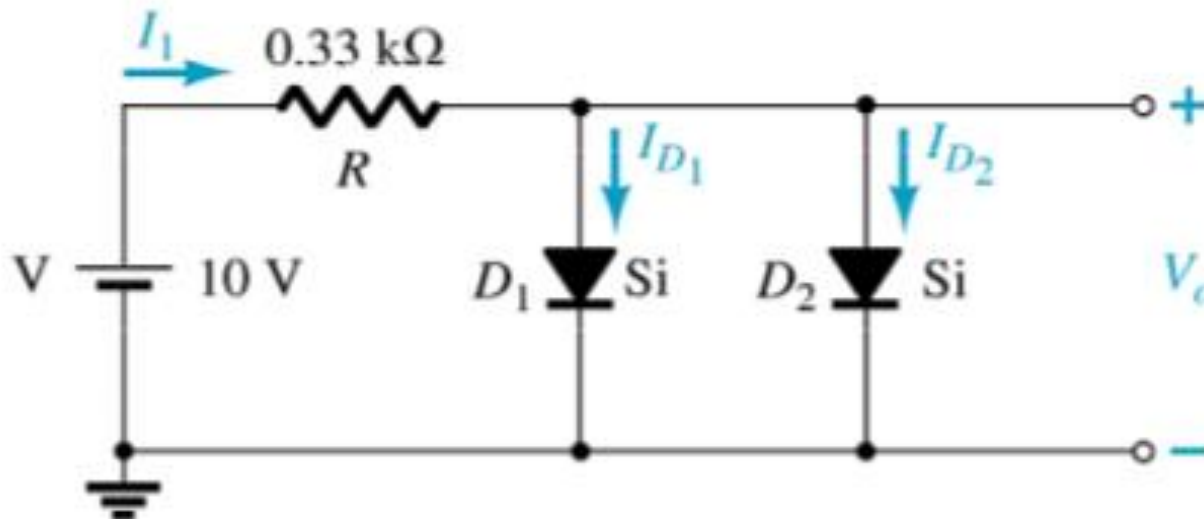
$$V_R = I_D R$$

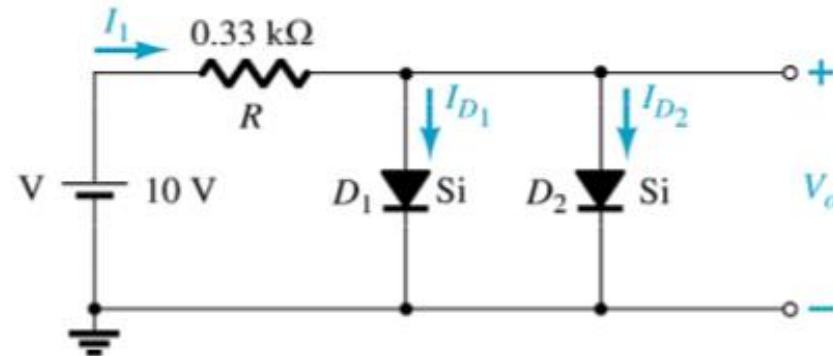
$$V_R = 0 \text{ V}$$



Example #4

Determine V_D , I_1 , I_{D_1} , and I_{D_2} for the parallel diode configuration





$$V_D = 0.7 \text{ V}$$

$$V_{D1} = V_{D2} = V_o = 0.7 \text{ V}$$

$$V_R = 9.3 \text{ V}$$

$$I_R = \frac{V - V_D}{R} = \frac{10 \text{ V} - 0.7 \text{ V}}{0.33 \text{ k}\Omega} = 28 \text{ mA}$$

$$I_{D1} = I_{D2} = \frac{28 \text{ mA}}{2} = 14 \text{ mA}$$

